





1-layer Aluminium-Carrier Aluminium-Träger

Top L1	solder mask		15 µm	Lacquer
	outer layer		35 µm	Copper
	prepreg		100 µm	Dielectric
	Aluminium		1500 µm	Alloy
Total finished thickness:			1,65 mm	
Tolerance ±			10%	
Maximum thickness			1,82 mm	
Minimum thickness			1,49 mm	

Note:

The following options are available for copper thickness, prepreg and aluminium-core thickness:
Standards are marked **bold**

Hinweis:

Für Kupferdicke, Prepreg und Aluminiumdicke gibt es folgende Wahlmöglichkeiten:
Standards sind **fett** markiert

Copper thickness	35 / 70 [µm]
Dielectric thickness	100 [µm] (38 [µm] only Bergquist HPL)
Dielectric W/mK	1,5 / 3,0 / 12,0 [W/mK]
Aluminium thickness	0,5 / 0,9 / 1,5 / 1,9 / 3,0 [mm]
Alloy:	may vary slightly